

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	356995	(dielectric polymer polyimide polyimide photoimageble glass (silicon adj (nitride dioxide oxynitride)) sin sion) with (spacer spacing spaced support post)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/30 09:10
L2	23593	(die chip semiconductor dice ic (integrated adj circuit) microelectronic microprocessor) with 1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/30 09:11
L3	8024	2 with (adjacent\$2 between stack\$4 mount\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/30 09:13
L4	3242	(bondpad pad bonding pad paddle terminal contact electrode) same 3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/30 09:14
L5	1339	(active top bottom upper lower) same 4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/30 09:40
L6	2	"6287895".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/30 09:41
L7	2	"6593662".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/30 09:54
L8	2	"6400007".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/30 10:24

## EAST Search History

L9	2	"6400007".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/07/30 10:25
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